

Vishay Siliconix

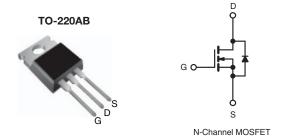
### **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	500				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 0.450				
Q <sub>g</sub> (Max.) (nC)	81				
Q <sub>gs</sub> (nC)	20				
Q <sub>gd</sub> (nC)	36				
Configuration	Single				





- Lower Gate Charge Qq Results in Simpler Drive
- Improved Gate, Avalanche and Dynamic dV/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage
- Compliant to RoHS Directive 2002/95/EC



#### **APPLICATIONS**

**FEATURES** 

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supplies
- High Speed Power Switching

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRFB13N50APbF		
Lead (FD)-lifee	SiHFB13N50A-E3		
SnPb	IRFB13N50A		
SIFD	SiHFB13N50A		

ABSOLUTE MAXIMUM RATINGS ( $T_C$	– 25 O, um	ess offici wis				
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	500	V	
Gate-Source Voltage			V <sub>GS</sub>	± 30	<b>□</b>	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	,	14		
		T <sub>C</sub> = 100 °C	I <sub>D</sub>	9.1	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	56		
Linear Derating Factor				2.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	560	mJ	
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	14	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	25	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			P <sub>D</sub>	250	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	9.2	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>		
Mounting Toyour	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque				1.1	N·m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Starting  $T_J$  = 25 °C, L = 5.7 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  =14 A, dV/dt = 7.6 V/ns (see fig. 12a).
- c.  $I_{SD} \le 14$  A,  $dI/dt \le 250$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFB13N50A, SiHFB13N50A

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greasd Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	0.50		

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	500	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	0.55	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 30 V	-	-	± 100	nA
Zaus Cata Valta as Dusin Comment		V <sub>DS</sub> =	= 500 V, V <sub>GS</sub> = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 8.4 A <sup>b</sup>	-	-	0.450	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 50 V, I <sub>D</sub> = 8.4 A	8.1	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$	-	1910	-	
Output Capacitance	Coss	1	$V_{DS} = 25 \text{ V},$	-	290	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	11	-	
Output Conscitones	_		V <sub>DS</sub> = 1.0 V, f = 1.0 MHz	-	2730	-	- pF
Output Capacitance	$C_{oss}$	$V_{GS} = 0 V$	V <sub>DS</sub> = 400 V, f = 1.0 MHz	-	82	2730 - pF	
Effective Output Capacitance	C <sub>oss</sub> eff.	1	V <sub>DS</sub> = 0 V to 400 V <sup>c</sup>	-	160	-	
Total Gate Charge	$Q_g$			-	-	81	
Gate-Source Charge	$Q_{gs}$		$I_D = 14 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	20	nC
Gate-Drain Charge	$Q_{gd}$			-	-	36	
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>GS</sub> = 10 V		-	15	-	ns
Rise Time	t <sub>r</sub>		$V_{DD} = 250 \text{ V}, I_D = 14 \text{ A},$ $R_a = 7.5 \Omega,$	-	39	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		see fig. 10 <sup>b</sup>	-	39	-	
Fall Time	t <sub>f</sub>			-	31	-	
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET sym	MOSFET symbol showing the		-	14	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	_	56	_ ^
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 14 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	1.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			-	370	550	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	T <sub>J</sub> =	25 °C, I <sub>F</sub> = 14 A, °C, dI/dt = 100 A/µs <sup>b</sup>	-	4.4	6.5	μC
Body Diode Reverse Recovery Current	I <sub>RRM</sub>	1,1 - 120	5, and = 1007 v po	-	21	31	Α
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	ırn-on time is negligible (turn-	on is dor	ninated b	v L <sub>s</sub> and	L <sub>D</sub> )

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.
- c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

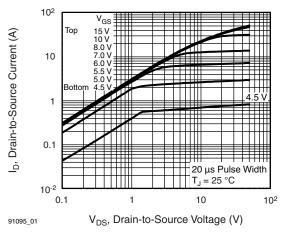


Fig. 1 - Typical Output Characteristics

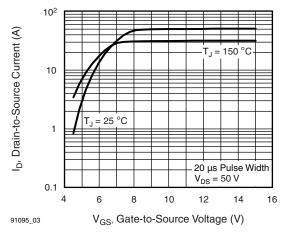


Fig. 3 - Typical Transfer Characteristics

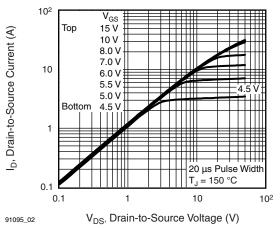


Fig. 2 - Typical Output Characteristics

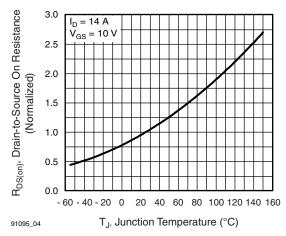


Fig. 4 - Normalized On-Resistance vs. Temperature

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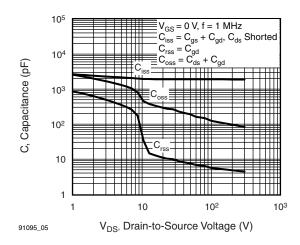


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

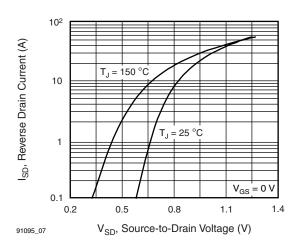


Fig. 7 - Typical Source-Drain Diode Forward Voltage

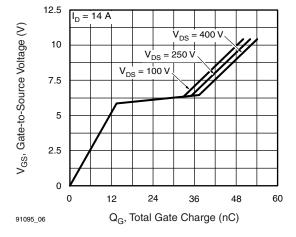


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

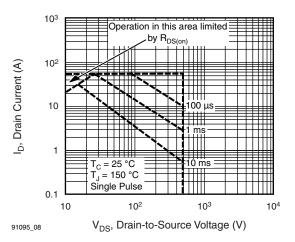


Fig. 8 - Maximum Safe Operating Area



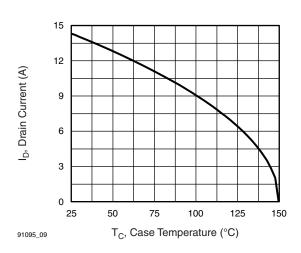


Fig. 9 - Maximum Drain Current vs. Case Temperature

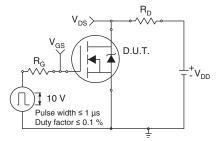


Fig. 10a - Switching Time Test Circuit

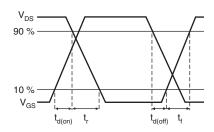


Fig. 10b - Switching Time Waveforms

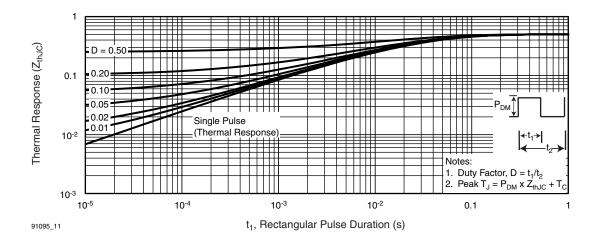


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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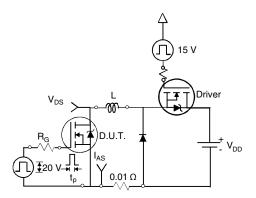


Fig. 12a - Unclamped Inductive Test Circuit

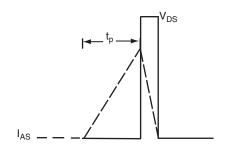


Fig. 12b - Unclamped Inductive Waveforms

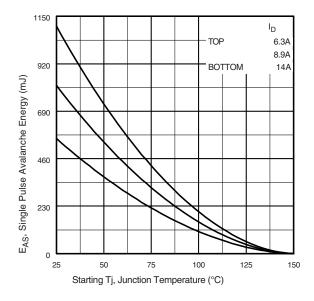


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

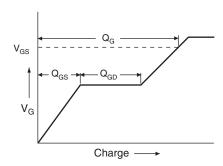


Fig. 13a - Basic Gate Charge Waveform

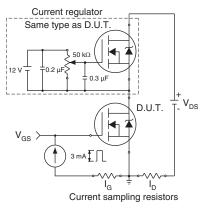
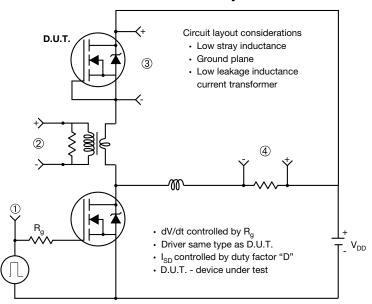


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



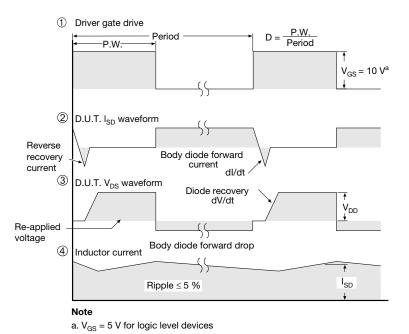


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and

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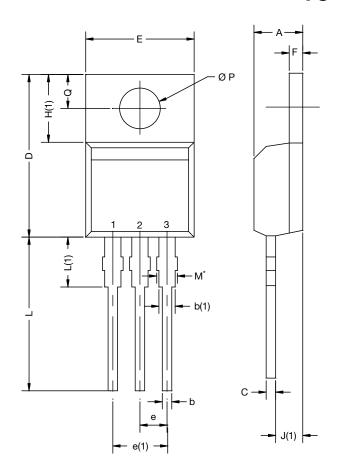


reliability data, see www.vishay.com/ppg?91095.





### TO-220-1



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

 $\bullet$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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